

Description

The EG01 is a fast recovery diode of 400 V / 0.7 A. The maximum $t_{\rm rr}$ of 100 ns is realized by optimizing a life-time control.

Features

•	V _{RM} 400	V
	I _{F(AV)} 0.7	
	V _F 2.0	
•	$t_{\rm rr1}$ 100	ns

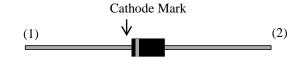
- Bare Leads: Pb-free (RoHS Compliant)
- Flammability: Equivalent to UL94V-0

Applications

- Secondary-side Rectifier Diode (Flyback Converter, LLC Converter, etc.)
- Freewheel Diode (Offline Buck Converter, Offline Buck-boost Converter, etc.)

Package

Axial (φ 2.7 × 5.0L / φ 0.6)





- (1) Cathode
- (2) Anode

Not to scale

Absolute Maximum Ratings

Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Rating	Unit
Nonrepetitive Peak Reverse Voltage	V_{RSM}		400	V
Repetitive Peak Reverse Voltage	V_{RM}		400	V
Average Forward Current	I _{F(AV)}	See Figure 2 and Figure 3	0.7	A
Surge Forward Current	I _{FSM}	Half cycle sine wave, positive side, 10 ms, 1 shot	15	A
I ² t Limiting Value	I^2t	$1 \text{ ms} \le t \le 10 \text{ ms}$	1.1	A^2s
Junction Temperature	T_{J}		-40 to 150	°C
Storage Temperature	T_{STG}		-40 to 150	°C

Electrical Characteristics

Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
E. a. 1 W. Iv. a. D. a.	V_{F}	$T_J = 25 ^{\circ}\text{C}, I_F = 0.7 \text{A}$	_	_	2.0	V
Forward Voltage Drop		$T_J = 100 ^{\circ}\text{C}, I_F = 0.7 \text{A}$	_	1.0	_	V
Reverse Leakage Current	I_R	$V_R = V_{RM}$			50	μA
Reverse Leakage Current under High Temperature	$H \cdot I_R$	$V_R = V_{RM}, T_J = 100 ^{\circ}C$	_	_	300	μΑ
	t _{rr1}	$I_F = I_{RP} = 100 \text{ mA},$ 90% recovery point, $T_J = 25 \text{ °C}$	_	_	100	ns
Reverse Recovery Time	t _{rr2}	$I_F = 100 \text{ mA},$ $I_{RP} = 200 \text{ mA},$ 75% recovery point, $T_J = 25 \text{ °C}$	_	_	50	ns
Thermal Resistance (1)	R _{th(J-L)}	See Figure 1	_	_	20	°C/W

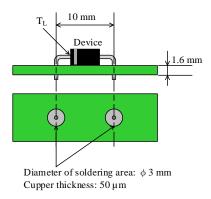


Figure 1. Lead Temperature Measurement Conditions

 $^{^{(1)}}R_{\text{th (J-L)}}$ is thermal resistance between junction and lead.

Rating and Characteristic Curves

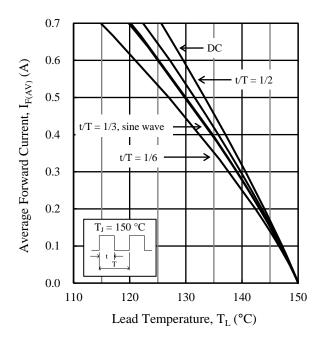


Figure 2. Typical Characteristics: $I_{F(AV)}$ vs. $T_L^{(2)}$ $(V_R = 0 V)$

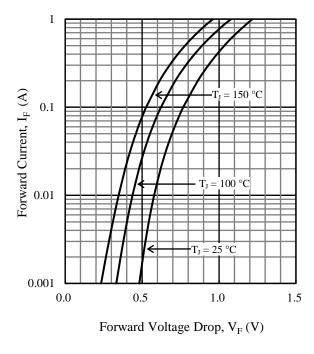
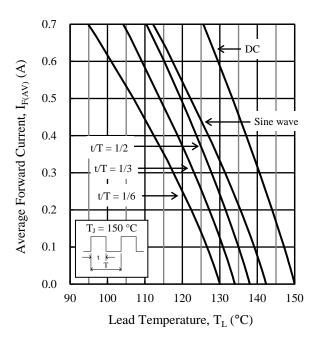


Figure 4. Typical Characteristics: I_F vs. V_F



Typical Characteristics: I_{F(AV)} vs. T_L⁽²⁾ Figure 3. $(V_R = 400 \text{ V})$

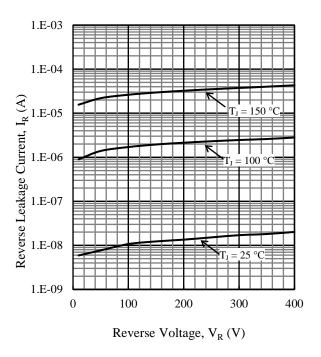
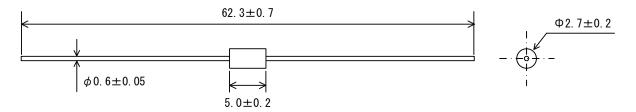


Figure 5. Typical Characteristics: I_R vs. V_R

⁽²⁾ See Figure 1 for the lead temperature measurement conditions.

Physical Dimensions

• Axial $(\varphi 2.7 \times 5.0 L / \varphi 0.6)$



NOTES:

- Dimensions in millimeters
- Bare leads: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time within the following limits: Flow: 260 ± 5 °C / 10 ± 1 s, 2 times Soldering Iron: 380 ± 10 °C / 3.5 ± 0.5 s, 1 time (Soldering should be at a distance of at least 1.5 mm from the body of the product.)

Marking Diagram

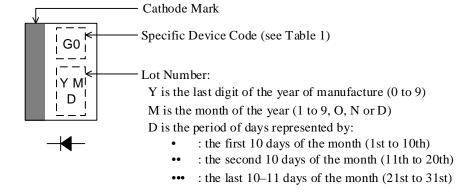


Table 1. Specific Device Code

Specific Device Code	Part Number
G0	EG01

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